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**SN54ALS520, SN74ALS518, SN74ALS520, SN74ALS521**  
**8-BIT IDENTITY COMPARATORS**

SDAS224B – JUNE 1982 – REVISED NOVEMBER 1995

- Compare Two 8-Bit Words
- Choice of Totem-Pole or Open-Collector Outputs
- SN74ALS518 and 'ALS520 Have 20-k $\Omega$  Pullup Resistors on Q Inputs
- Package Options Include Plastic Small-Outline (DW) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

TYPE	INPUT PULLUP RESISTOR	OUTPUT FUNCTION AND CONFIGURATION
SN74ALS518	Yes	P = Q open collector
'ALS520	Yes	$\overline{P} = \overline{Q}$ totem pole
SN74ALS521 <sup>‡</sup>	No	$\overline{P} = \overline{Q}$ totem pole

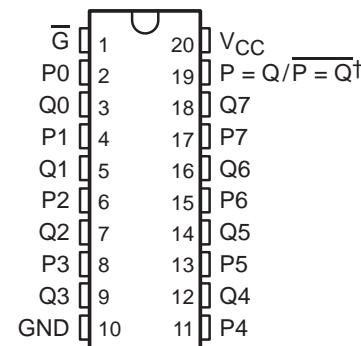
<sup>‡</sup> SN74ALS521 is identical to 'ALS688.

### description

These identity comparators perform comparisons on two 8-bit binary or BCD words. The SN74ALS518 provides P = Q outputs, while the 'ALS520 and SN74ALS521 provide  $\overline{P} = \overline{Q}$  outputs. The SN74ALS518 has an open-collector output. The SN74ALS518 and 'ALS520 feature 20-k $\Omega$  pullup resistors on the Q inputs for analog or switch data.

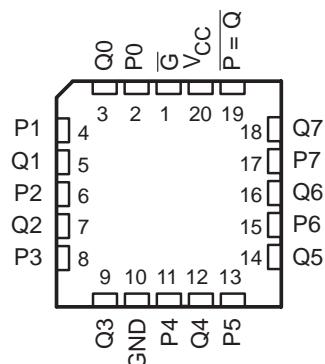
The SN54ALS520 is characterized for operation over the full military temperature range of  $-55^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ . The SN74ALS518, SN74ALS520, and SN74ALS521 are characterized for operation from  $0^{\circ}\text{C}$  to  $70^{\circ}\text{C}$ .

**SN54ALS520 . . . J PACKAGE**  
**SN74ALS518, SN74ALS520,**  
**SN74ALS521 . . . DW OR N PACKAGE**  
**(TOP VIEW)**



<sup>†</sup> P = Q for SN74ALS518  
P = Q for 'ALS520 and SN74ALS521

**SN54ALS520 . . . FK PACKAGE**  
**(TOP VIEW)**



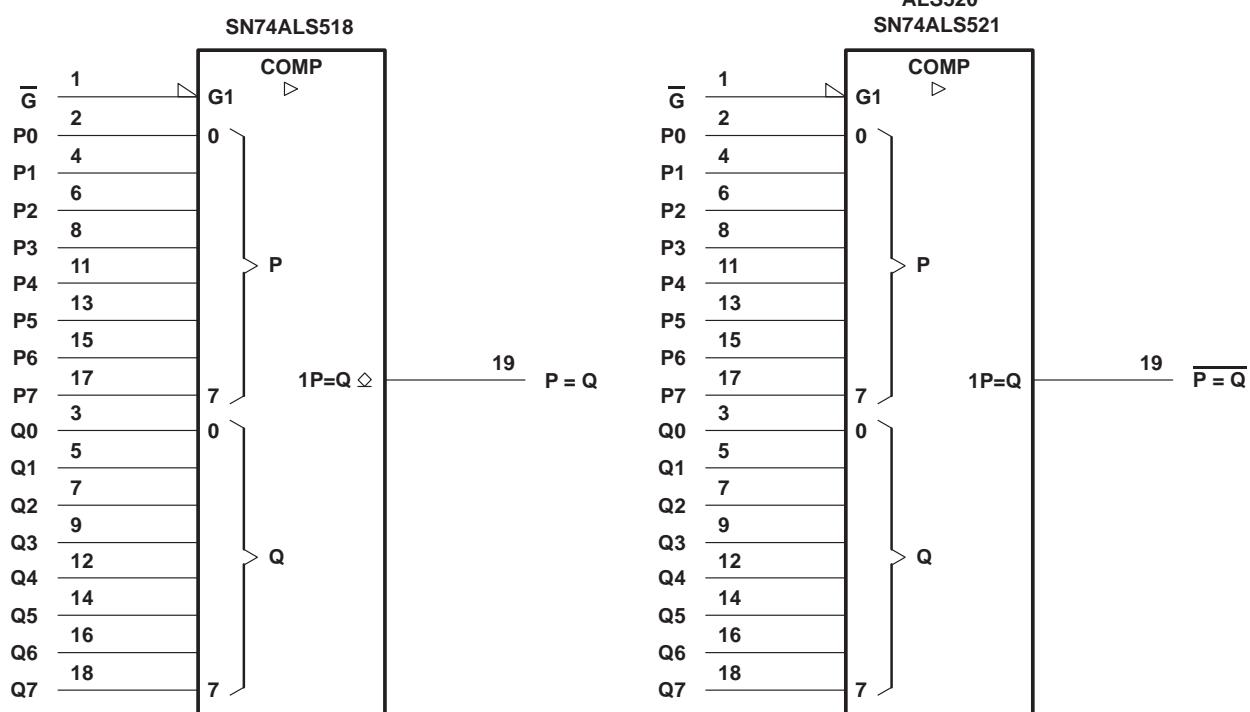
FUNCTION TABLE

INPUTS		OUTPUTS	
DATA P, Q	ENABLE $\overline{G}$	P = Q	$\overline{P} = \overline{Q}$
P = Q	L	H	L
P > Q	L	L	H
P < Q	L	L	H
X	H	L	H

**SN54ALS520, SN74ALS518, SN74ALS520, SN74ALS521**  
**8-BIT IDENTITY COMPARATORS**

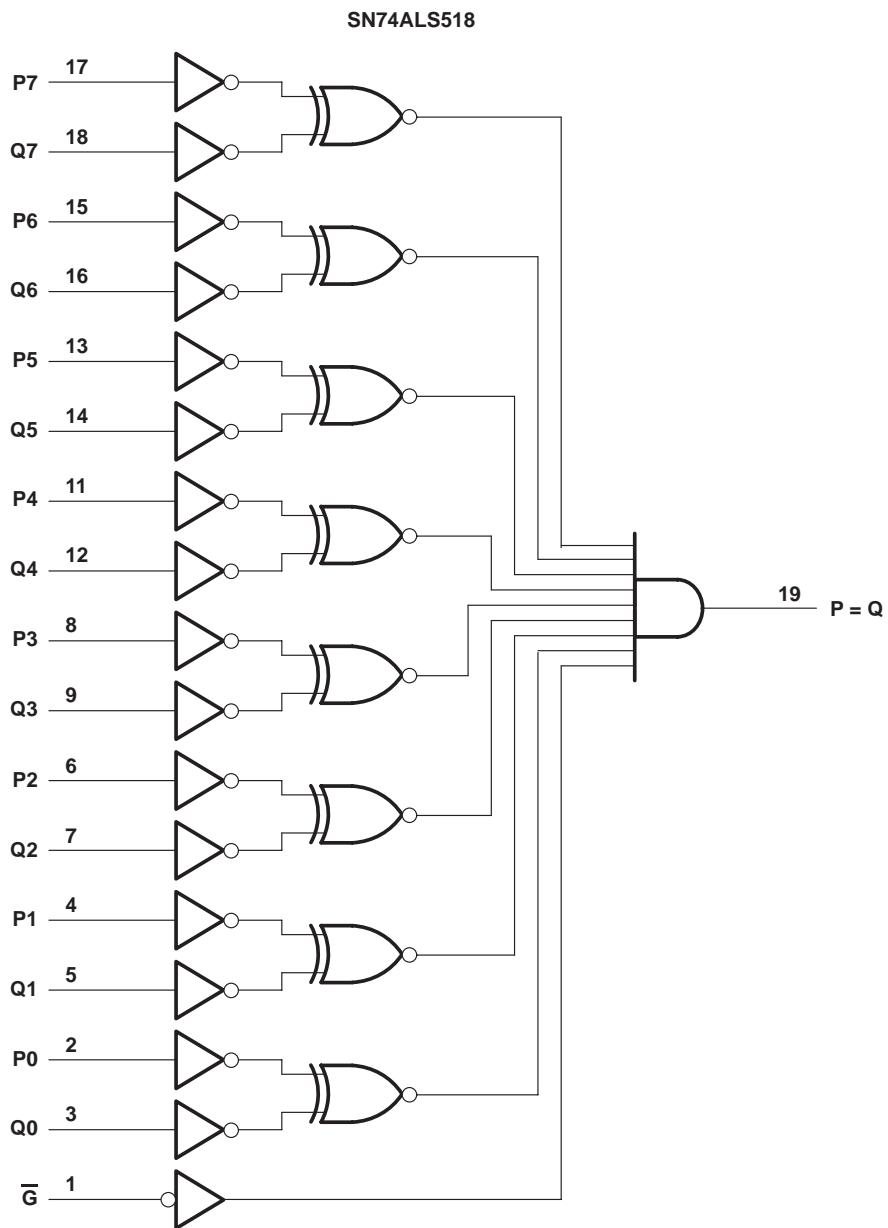
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**logic symbols†**



† These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

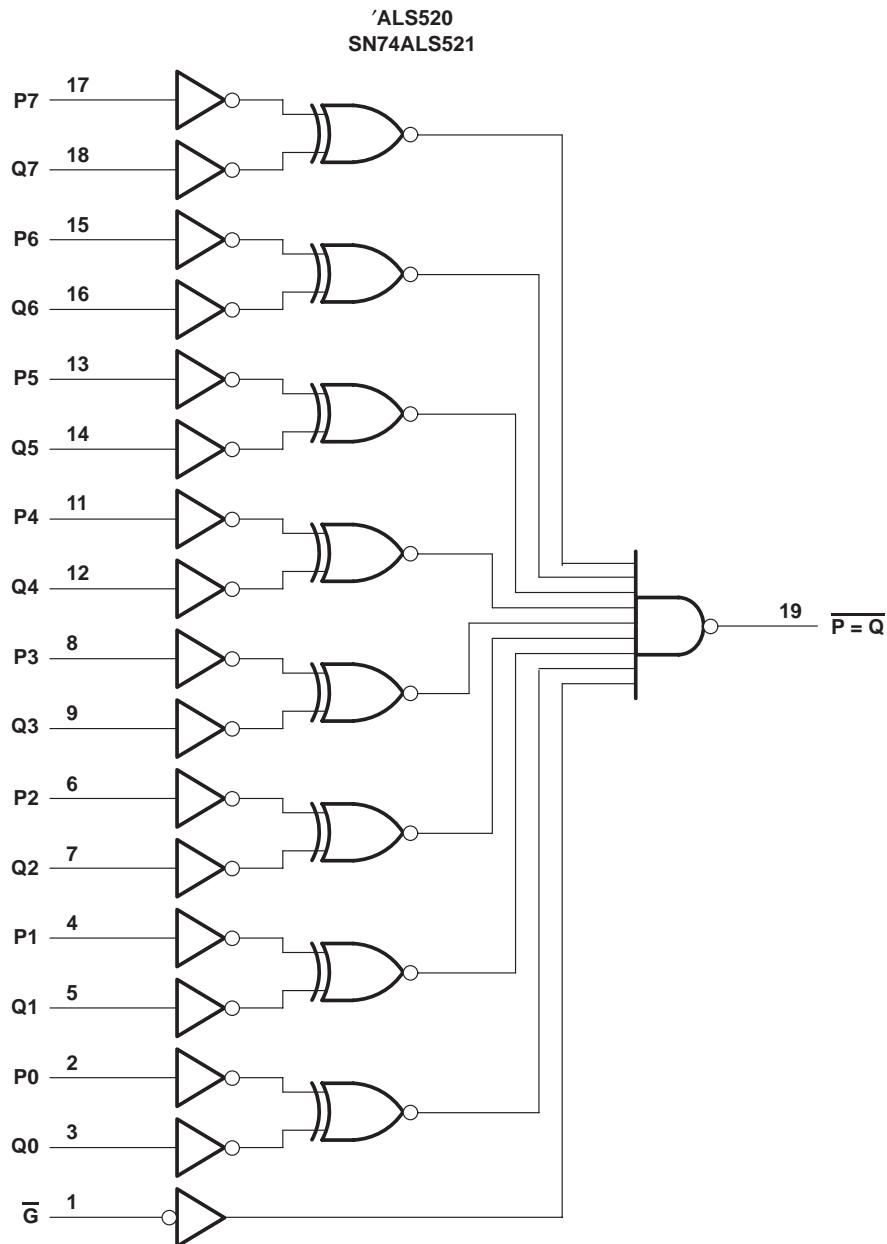
**logic diagrams (positive logic)**



**SN54ALS520, SN74ALS518, SN74ALS520, SN74ALS521**  
**8-BIT IDENTITY COMPARATORS**

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**logic diagrams (positive logic) (continued)**



**SN54ALS520, SN74ALS518, SN74ALS520, SN74ALS521**  
**8-BIT IDENTITY COMPARATORS**

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**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†**

Supply voltage, $V_{CC}$ .....	7 V		
Input voltage, $V_I$ : Q inputs .....	$V_{CC} + 0.5$ V or 5.5 V, whichever is less		
All other inputs .....	7 V		
Off-state output voltage .....	7 V		
Operating free-air temperature range, $T_A$ : SN74ALS518 .....	0°C to 70°C		
Storage temperature range .....	-65°C to 150°C		

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

**recommended operating conditions**

		SN74ALS518			UNIT
		MIN	NOM	MAX	
$V_{CC}$	Supply voltage	4.5	5	5.5	V
$V_{IH}$	High-level input voltage	2			V
$V_{IL}$	Low-level input voltage			0.8	V
$V_{OH}$	High-level output voltage			5.5	V
$I_{OL}$	Low-level output current			24	mA
$T_A$	Operating free-air temperature	0	70		°C

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER	TEST CONDITIONS	SN74ALS518			UNIT
		MIN	TYP‡	MAX	
$V_{IK}$	$V_{CC} = 4.5$ V, $I_I = -18$ mA			-1.5	V
$I_{OH}$	$V_{CC} = 5.5$ V, $V_{OH} = 5.5$ V			0.1	mA
$V_{OL}$	$V_{CC} = 4.5$ V	$I_{OL} = 12$ mA	0.25	0.4	V
		$I_{OL} = 24$ mA	0.35	0.5	
$I_I$	Q inputs All other inputs	$V_I = 5.5$ V		0.1	mA
		$V_I = 7$ V		0.1	
$I_{IH}$	Q inputs All other inputs	$V_{CC} = 5.5$ V, $V_I = 2.7$ V		-0.2	mA
				20	
$I_{IL}$	Q inputs All other inputs	$V_{CC} = 5.5$ V, $V_I = 0.4$ V		-0.6	mA
				-0.1	
$I_{CC}$	$V_{CC} = 5.5$ V,	See Note 1		11	mA

‡ All typical values are at  $V_{CC} = 5$  V,  $T_A = 25^\circ\text{C}$ .

NOTE 1:  $I_{CC}$  is measured with  $G$  grounded, and  $P$  and  $Q$  at 4.5 V.

# SN54ALS520, SN74ALS518, SN74ALS520, SN74ALS521 8-BIT IDENTITY COMPARATORS

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switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> = 4.5 V to 5.5 V, C <sub>L</sub> = 50 pF, R <sub>L</sub> = 680 Ω, T <sub>A</sub> = MIN to MAX†	UNIT	
			SN74ALS518		
			MIN	MAX	
t <sub>PLH</sub>	P or Q	P = Q	15	33	ns
t <sub>PHL</sub>			3	15	
t <sub>PLH</sub>	$\overline{G}$	P = Q	15	33	ns
t <sub>PHL</sub>			3	15	

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡**

Supply voltage, $V_{CC}$ .....	7 V
Input voltage, $V_I$ : Q inputs of 'ALS520 .....	$V_{CC} + 0.5$ V or 5.5 V, whichever is less
All other inputs .....	7 V
Operating free-air temperature range, $T_A$ : SN54ALS520 .....	-55°C to 125°C
SN74ALS520, SN74ALS521 .....	0°C to 70°C
Storage temperature range .....	-65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### **recommended operating conditions**

		SN54ALS520			SN74ALS520 SN74ALS521			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V <sub>CC</sub>	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
V <sub>IH</sub>	High-level input voltage		2			2		V
V <sub>IL</sub>	Low-level input voltage			0.7			0.8	V
I <sub>OH</sub>	High-level output current			-1			-2.6	mA
I <sub>OL</sub>	Low-level output current			12			24	mA
T <sub>A</sub>	Operating free-air temperature	-55		125	0		70	°C

**SN54ALS520, SN74ALS518, SN74ALS520, SN74ALS521**  
**8-BIT IDENTITY COMPARATORS**

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**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER	TEST CONDITIONS	SN54ALS520			SN74ALS520 SN74ALS521			UNIT
		MIN	TYPT <sup>†</sup>	MAX	MIN	TYPT <sup>†</sup>	MAX	
V <sub>IK</sub>	V <sub>CC</sub> = 4.5 V, I <sub>I</sub> = -18 mA			-1.5			-1.5	V
V <sub>OH</sub>	V <sub>CC</sub> = 4.5 V to 5.5 V, I <sub>OH</sub> = -0.4 mA	V <sub>CC</sub> - 2			V <sub>CC</sub> - 2			V
	V <sub>CC</sub> = 4.5 V	I <sub>OH</sub> = -1 mA	2.4	3.3				
		I <sub>OH</sub> = -2.6 mA			2.4	3.2		
V <sub>OL</sub>	V <sub>CC</sub> = 4.5 V	I <sub>OL</sub> = 12 mA	0.25	0.4	0.25	0.4		V
		I <sub>OL</sub> = 24 mA			0.35	0.5		
I <sub>I</sub>	'ALS520 Q inputs	V <sub>CC</sub> = 5.5 V	V <sub>I</sub> = 5.5 V		0.1		0.1	mA
	All other inputs		V <sub>I</sub> = 7 V		0.1		0.1	
I <sub>IH</sub>	'ALS520 Q inputs	V <sub>CC</sub> = 5.5 V, V <sub>I</sub> = 2.7 V		-0.2		-0.2		mA
	All other inputs			20		20		
I <sub>IL</sub>	'ALS520 Q inputs	V <sub>CC</sub> = 5.5 V, V <sub>I</sub> = 0.4 V		-0.6		-0.6		mA
	All other inputs			-0.1		-0.1		
I <sub>O</sub> <sup>‡</sup>	V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 2.25 V		-20	-112	-30	-112		mA
I <sub>CC</sub>	'ALS520	V <sub>CC</sub> = 5.5 V, See Note 1		12	19	12	19	mA
	SN74ALS521			12	19	12	19	

<sup>†</sup> All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

<sup>‡</sup> The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I<sub>OS</sub>.  
NOTE 1: I<sub>CC</sub> is measured with G grounded, and P and Q at 4.5 V.

**switching characteristics (see Figure 1)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> = 4.5 V to 5.5 V, C <sub>L</sub> = 50 pF, R <sub>L</sub> = 500 Ω, T <sub>A</sub> = MIN to MAX <sup>§</sup>				UNIT	
			SN54ALS520		SN74ALS520 SN74ALS521			
			MIN	MAX	MIN	MAX		
t <sub>PLH</sub>	P or Q	P = Q	3	19	3	12	ns	
			3	25	5	20		
t <sub>PLH</sub>	G	P = Q	2	18	2	12	ns	
			5	23	5	22		

<sup>§</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

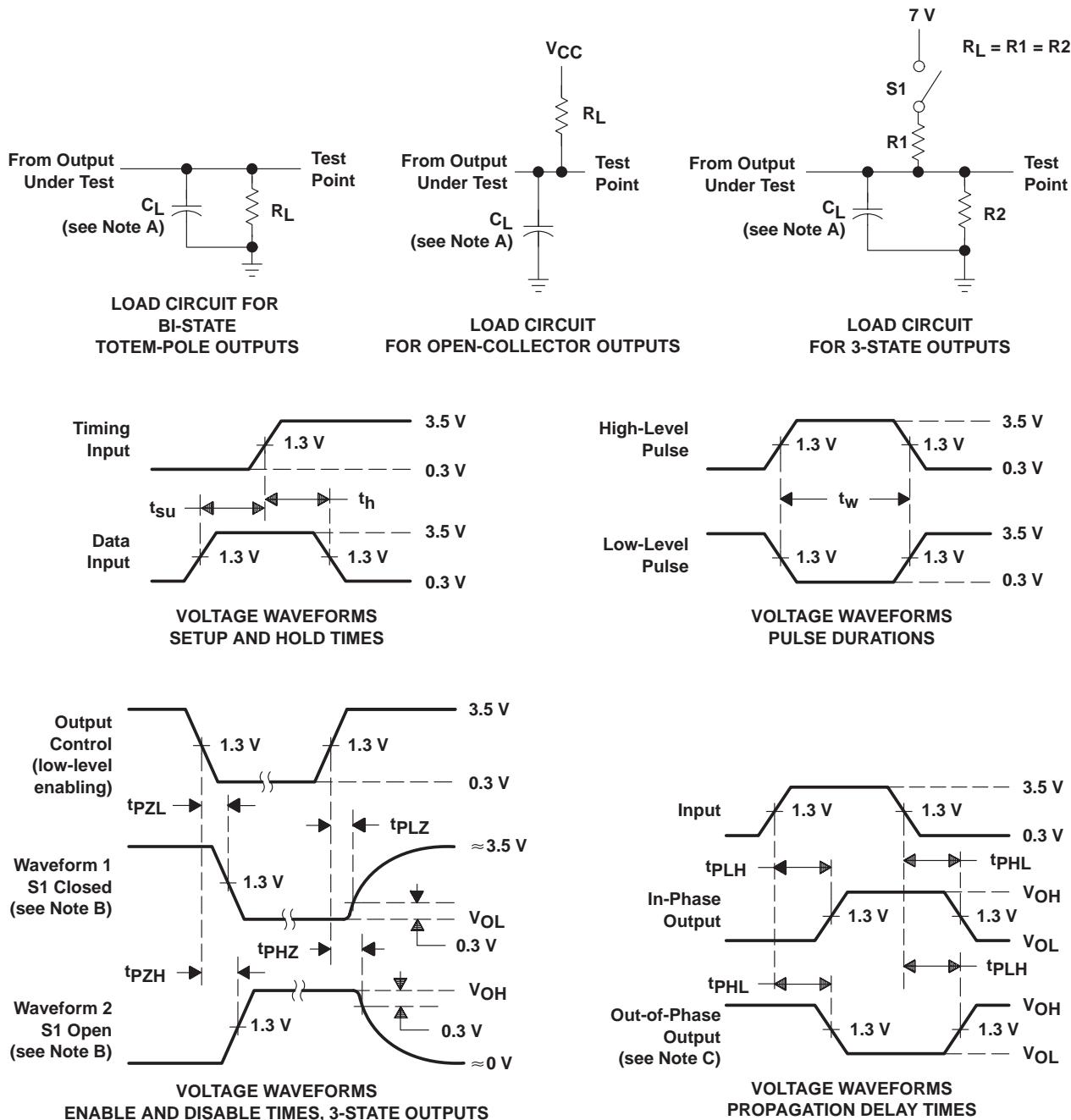


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**SN54ALS520, SN74ALS518, SN74ALS520, SN74ALS521**  
**8-BIT IDENTITY COMPARATORS**

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**PARAMETER MEASUREMENT INFORMATION**  
**SERIES 54ALS/74ALS AND 54AS/74AS DEVICES**



NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.  
 C. When measuring propagation delay items of 3-state outputs, switch S1 is open.  
 D. All input pulses have the following characteristics: PRR  $\leq$  1 MHz,  $t_r = t_f = 2$  ns, duty cycle = 50%.  
 E. The outputs are measured one at a time with one transition per measurement.

**Figure 1. Load Circuits and Voltage Waveforms**

**PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
5962-88691012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	5962-88691012A SNJ54ALS 520FK	<a href="#">Samples</a>
5962-8869101RA	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type	-55 to 125	5962-8869101RA SNJ54ALS520J	<a href="#">Samples</a>
SN54ALS520J	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type	-55 to 125	SN54ALS520J	<a href="#">Samples</a>
SN74ALS518DW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS518	<a href="#">Samples</a>
SN74ALS518DWE4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS518	<a href="#">Samples</a>
SN74ALS518N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74ALS518N	<a href="#">Samples</a>
SN74ALS518NS	PREVIEW	SO	NS	20		TBD	Call TI	Call TI	0 to 70	ALS518	
SN74ALS520DW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS520	<a href="#">Samples</a>
SN74ALS520DWG4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS520	<a href="#">Samples</a>
SN74ALS520N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74ALS520N	<a href="#">Samples</a>
SN74ALS520NSR	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS520	<a href="#">Samples</a>
SN74ALS521DW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS521	<a href="#">Samples</a>
SN74ALS521DWE4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS521	<a href="#">Samples</a>
SN74ALS521DWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS521	<a href="#">Samples</a>
SN74ALS521DWRE4	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS521	<a href="#">Samples</a>
SN74ALS521N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74ALS521N	<a href="#">Samples</a>
SN74ALS521NSR	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS521	<a href="#">Samples</a>

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SNJ54ALS520FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	5962-88691012A SNJ54ALS520FK	<span style="background-color: red; color: white;">Samples</span>
SNJ54ALS520J	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type	-55 to 125	5962-8869101RA SNJ54ALS520J	<span style="background-color: red; color: white;">Samples</span>

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBsolete:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "—" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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**OTHER QUALIFIED VERSIONS OF SN54ALS520, SN74ALS520 :**

- Catalog: [SN74ALS520](#)

- Military: [SN54ALS520](#)

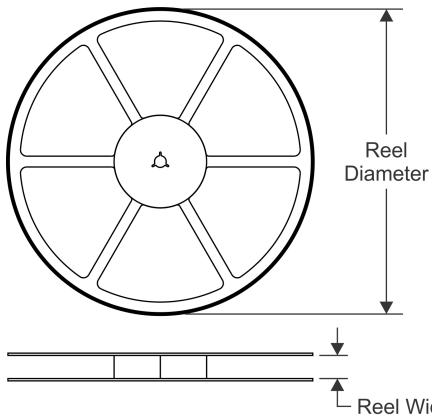
NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product

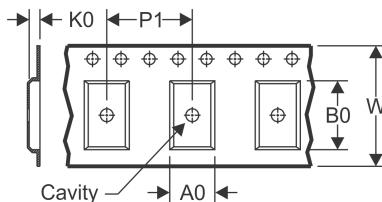
- Military - QML certified for Military and Defense Applications

**TAPE AND REEL INFORMATION**

**REEL DIMENSIONS**

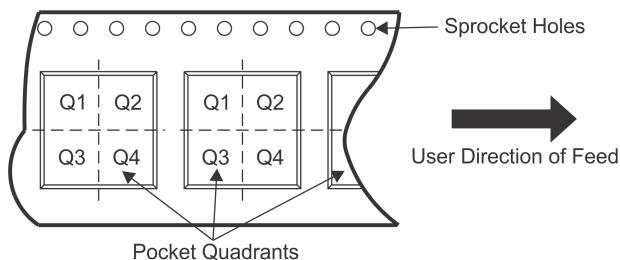


**TAPE DIMENSIONS**



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

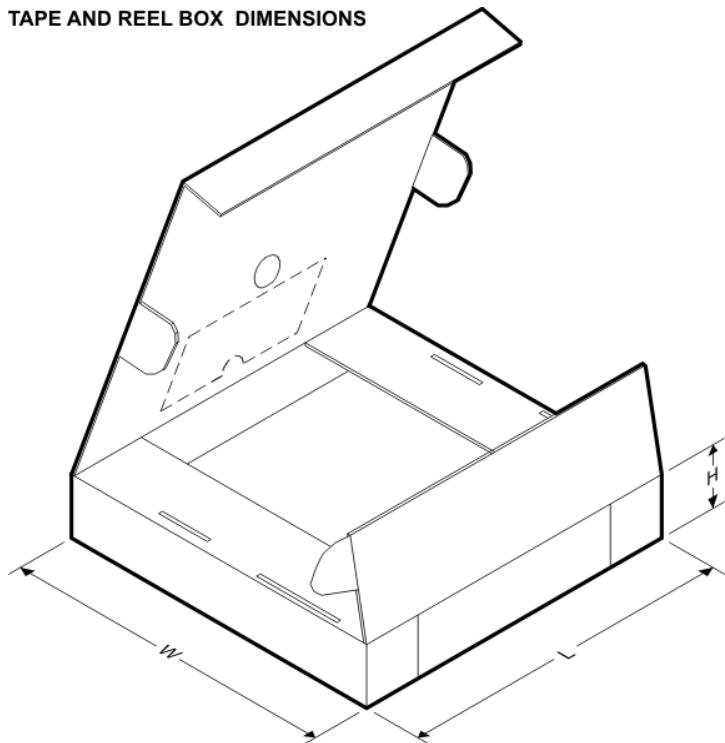
**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ALS520NSR	SO	NS	20	2000	330.0	24.4	9.0	13.0	2.4	4.0	24.0	Q1
SN74ALS521DWR	SOIC	DW	20	2000	330.0	24.4	10.8	13.3	2.7	12.0	24.0	Q1
SN74ALS521NSR	SO	NS	20	2000	330.0	24.4	9.0	13.0	2.4	4.0	24.0	Q1

**TAPE AND REEL BOX DIMENSIONS**



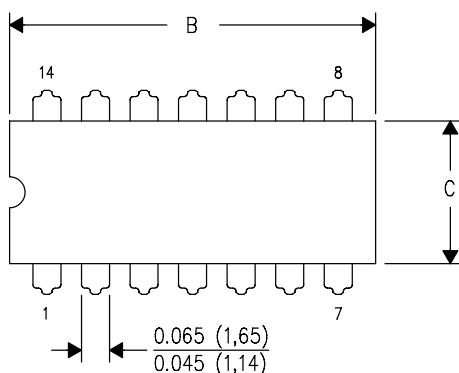
\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ALS520NSR	SO	NS	20	2000	367.0	367.0	45.0
SN74ALS521DWR	SOIC	DW	20	2000	367.0	367.0	45.0
SN74ALS521NSR	SO	NS	20	2000	367.0	367.0	45.0

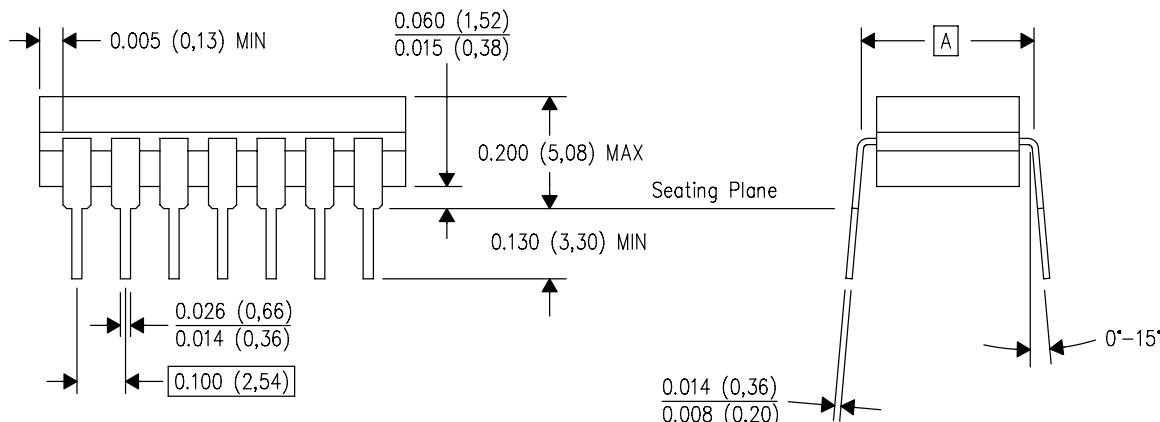
J (R-GDIP-T\*\*)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



DIM	PINS **	14	16	18	20
		A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX		0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN		—	—	—	—
C MAX		0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN		0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



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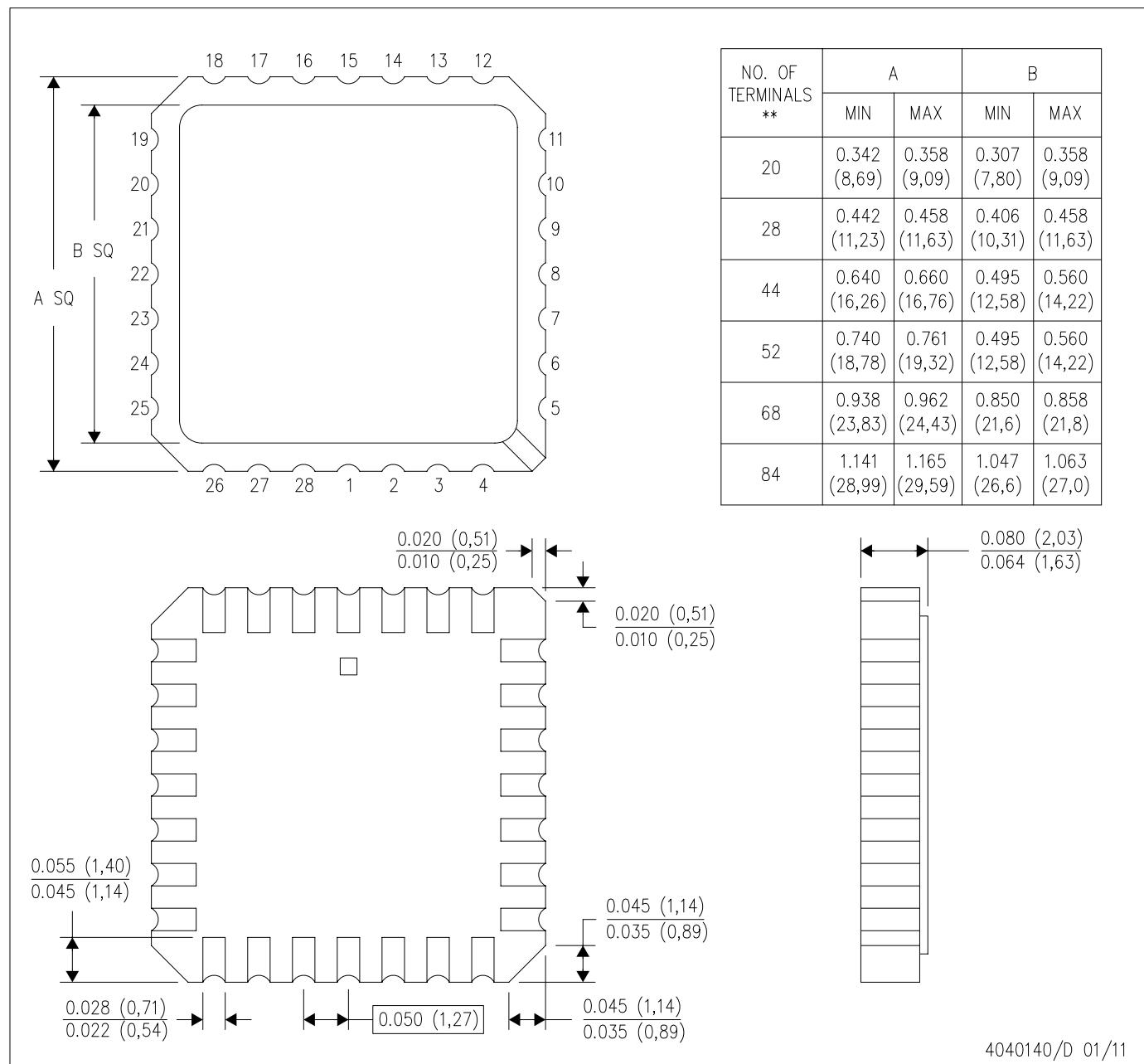
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

**FK (S-CQCC-N\*\*)**

28 TERMINAL SHOWN

**LEADLESS CERAMIC CHIP CARRIER**



NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. This package can be hermetically sealed with a metal lid.  
 D. Falls within JEDEC MS-004

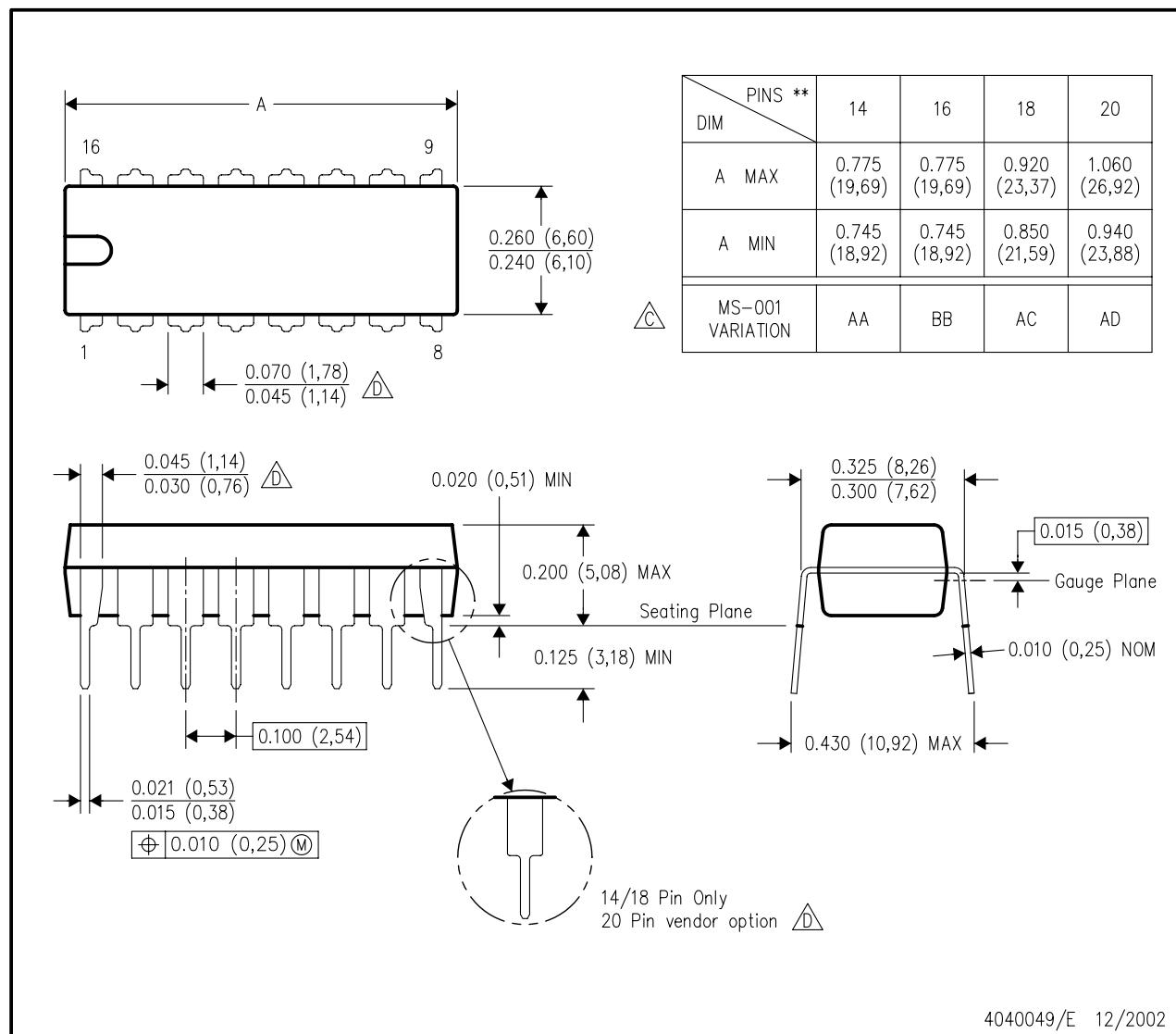
4040140/D 01/11

## MECHANICAL DATA

### N (R-PDIP-T\*\*)

16 PINS SHOWN

### PLASTIC DUAL-IN-LINE PACKAGE



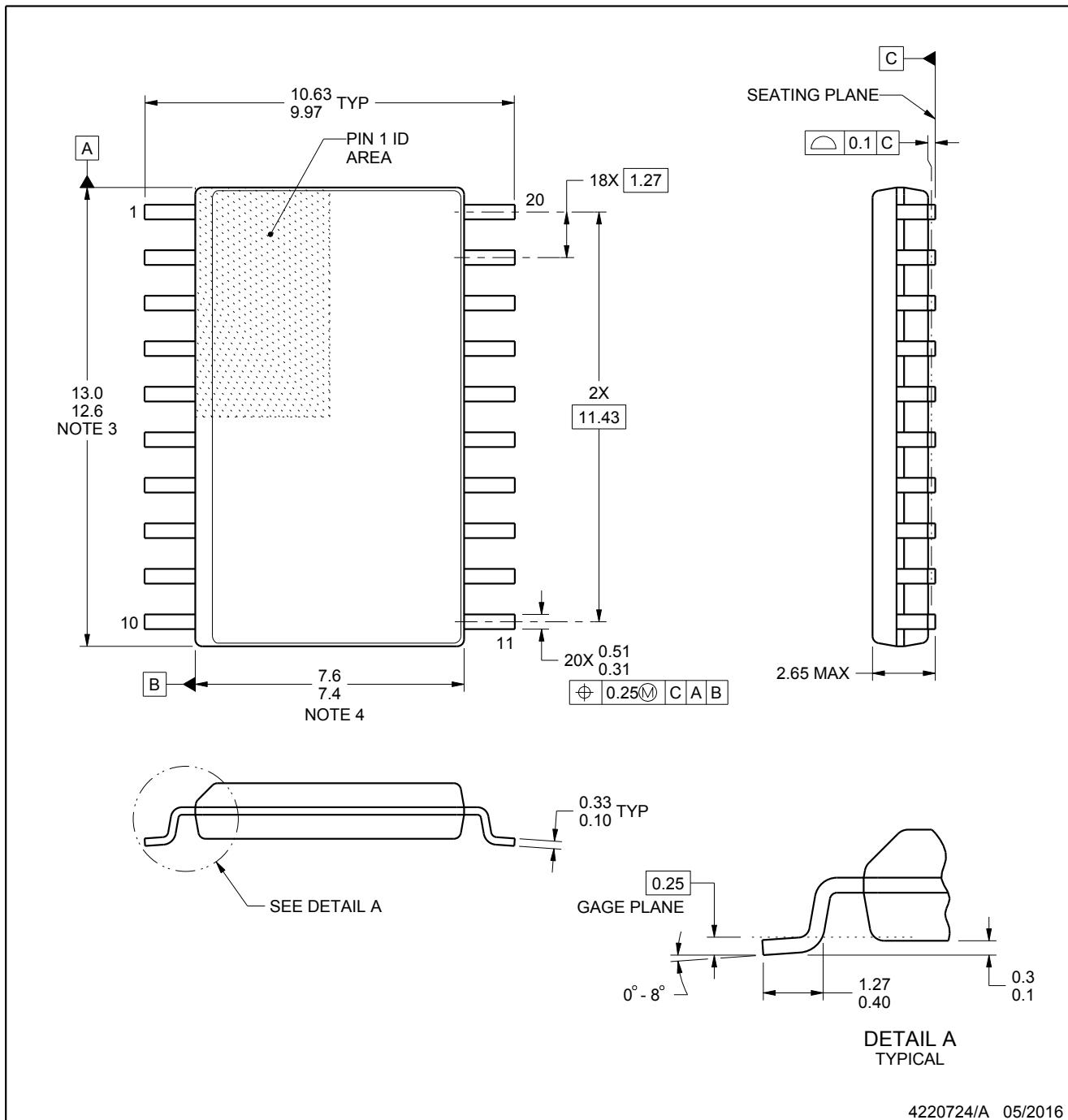
## PACKAGE OUTLINE

**DW0020A**



## **SOIC - 2.65 mm max height**

SOIC



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## NOTES:

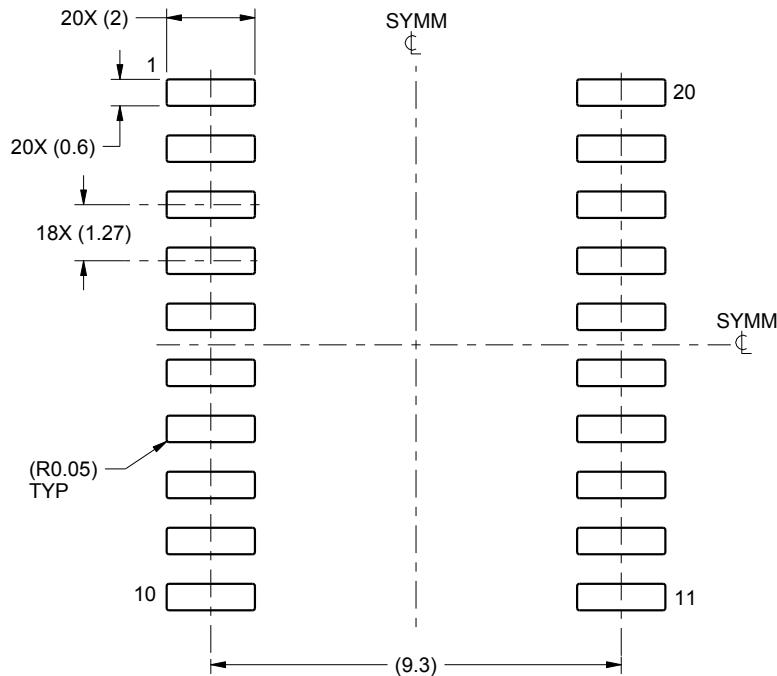
1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
5. Reference JEDEC registration MS-013.

## EXAMPLE BOARD LAYOUT

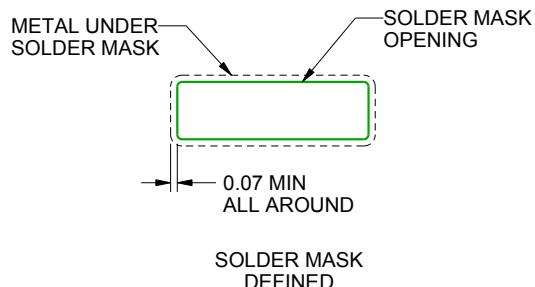
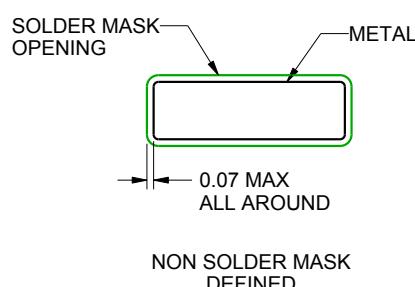
**DW0020A**

**SOIC - 2.65 mm max height**

SOIC



LAND PATTERN EXAMPLE  
SCALE:6X



SOLDER MASK DETAILS

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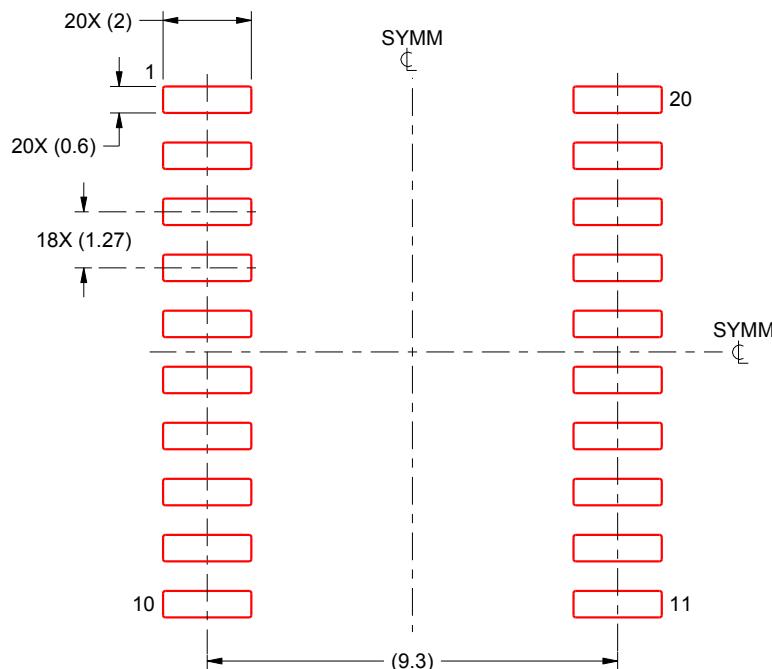
NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

**EXAMPLE STENCIL DESIGN****DW0020A****SOIC - 2.65 mm max height**

SOIC



**SOLDER PASTE EXAMPLE**  
BASED ON 0.125 mm THICK STENCIL  
SCALE:6X

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NOTES: (continued)

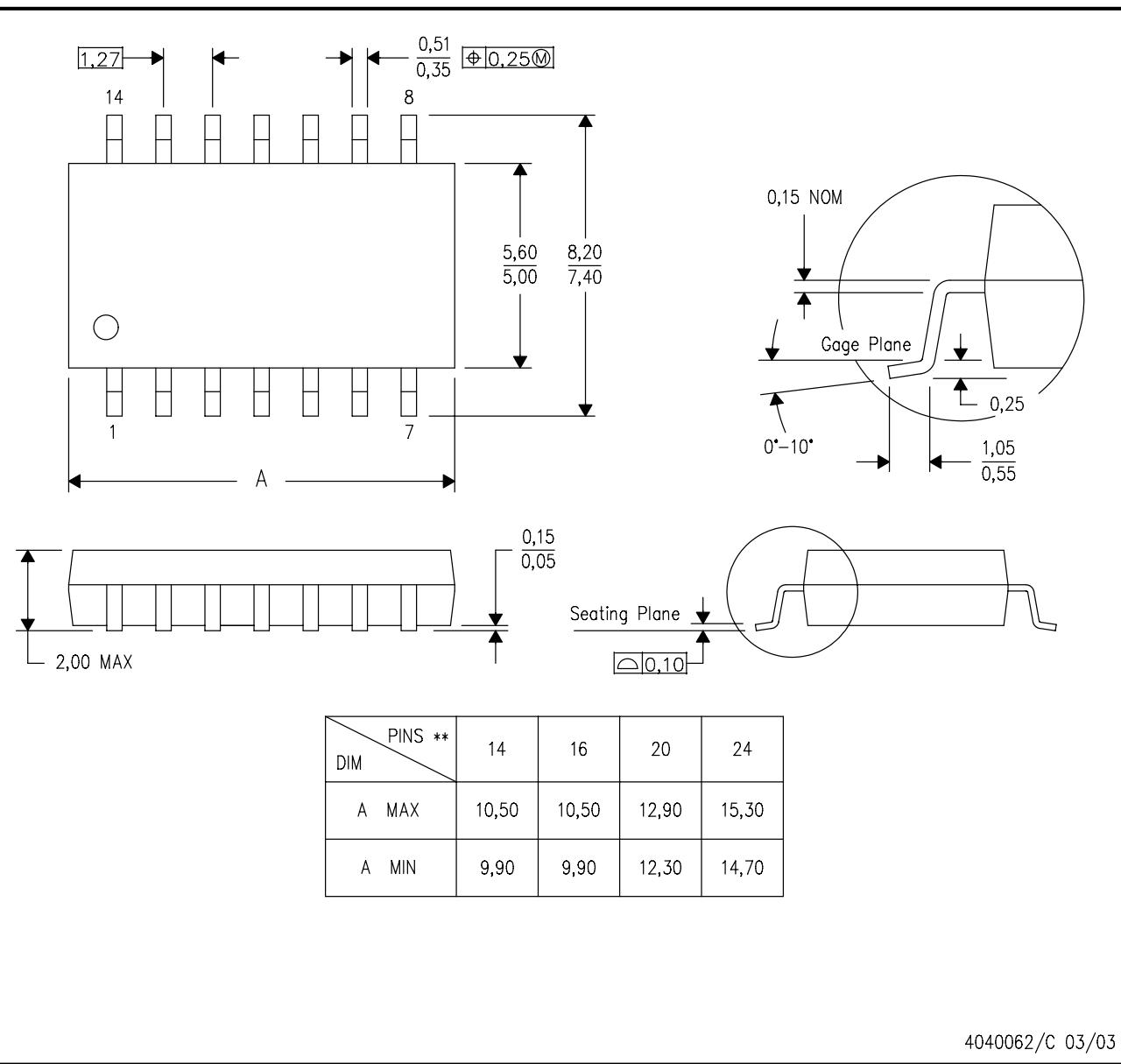
8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

## MECHANICAL DATA

NS (R-PDSO-G\*\*)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

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